Filename: PMP8580RevB - BoM.xls Generated: 4/30/2013 11:06:09 AM 48V -> 5V@300mA + 12V@80mA

| Quantity | Designator | Value | Description | Package | PartNumber | Manufacturer |
|----------|---|----------------|--|----------------|--------------------|---------------------|
| 5 | C1, C7, C10, C14, C19 | 0.1uF | CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603 | 0603 | GCM188R71H104KA57B | MuRata |
| 5 | C2, C3, C8, C11, C12 | 22uF | CAP, CERM, 22uF, 25V, +/-10%, X7R, 1210 | 1210 | GRM32ER71E226KE15L | MuRata |
| 3 | C4, C5, C6 | 2.2uF | CAP, CERM, 2.2uF, 100V, +/-10%, X7R, 1210 | 1210 | GRM32ER72A225KA35L | MuRata |
| 3 | C9, C16, C17 | 1uF | CAP, CERM, 1uF, 25V, +/-10%, X7R, 0805 | 0805 | GRM219R71E105KA88D | MuRata |
| 1 | C13 | 0.022uF | CAP, CERM, 0.022uF, 16V, +/-10%, X7R, 0402 | 0402 | GRM155R71C223KA01D | MuRata |
| 1 | C15 | 0.01uF | CAP, CERM, 0.01uF, 50V, +/-10%, X7R, 0402 | 0402 | GRM155R71H103KA88D | MuRata |
| 1 | C18 | 0.1uF | CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0402 | 0402 | GRM155R71C104KA88D | MuRata |
| 1 | C20 | 270pF | CAP, CERM, 270pF, 50V, +/-10%, X7R, 0402 | 0402 | GRM155R71H271KA01D | MuRata |
| 1 | C21 | 330pF | CAP, CERM, 330pF, 50V, +/-10%, X7R, 0402 | 0402 | GRM155R71H331KA01D | MuRata |
| 3 | D1, D3, D4 | 1.25V | Diode, P-N, 200V, 200A, SOT-23 | SOT-23 | BAS21-TP | Diodes Inc. |
| 2 | D2, D5 | 0.88V | Diode, Ultrafast, 200V, 1A, SMA | SMA | ES1D | Diodes Inc. |
| 1 | F1 | | Fuse, Resettable, 0.13A, 250V, SMD | 7.4x3.4x9.4 mm | MF-SM013/250-2 | Bourns |
| 3 | J1, J2, J3 | | Terminal Block, 6A, 3.5mm Pitch, 2-Pos, TH | 7.0x8.2x6.5mm | ED555/2DS | On-Shore Technology |
| 2 | L1, L2 | 80 ohm | 3A Ferrite Bead, 80 ohm @ 100MHz, SMD | 1206 | HI1206N800R-10 | Steward |
| 1 | Q1 | 150V | MOSFET, N-CH, 150V, 2.7A, SOIC-8 | SOIC-8 | SI4848DY-T1-E3 | Vishay-Siliconix |
| 1 | Q2 | 0.2V | Transistor, NPN, 40V, 0.2A, SOT-23 | SOT-23 | MMBT3904 | Fairchild |
| 6 | R1, R2, R4, R6, R8, R9 | 100 | RES, 100 ohm, 1%, 0.25W, 1206 | 1206 | CRCW1206100RFKEA | Vishay-Dale |
| 1 | | 3.9 | RES, 3.9 ohm, 5%, 0.25W, 1206 | 1206 | CRCW12063R90JNEA | Vishay-Dale |
| 1 | R5 | 150k | RES, 150k ohm, 1%, 0.25W, 1206 | 1206 | CRCW1206150KFKEA | Vishay-Dale |
| 1 | R7 | 100 | RES, 100 ohm, 1%, 0.063W, 0402 | 0402 | CRCW0402100RFKED | Vishay-Dale |
| 1 | R10 | 47 | RES, 47 ohm, 5%, 0.063W, 0402 | 0402 | CRCW040247R0JNED | Vishay-Dale |
| 3 | R11, R12, R13 | 1.00k | RES, 1.00k ohm, 1%, 0.063W, 0402 | 0402 | CRCW04021K00FKED | Vishay-Dale |
| 2 | R14, R20 | 5.1k | RES, 5.1k ohm, 5%, 0.063W, 0402 | 0402 | CRCW04025K10JNED | Vishay-Dale |
| 3 | R15, R17, R22 | 750, open, 750 | RES, 750 ohm, 5%, 0.063W, 0402 | 0402 | CRCW0402750RJNED | Vishay-Dale |
| 2 | R16, R25 | 1.8k | RES, 1.8k ohm, 5%, 0.063W, 0402 | 0402 | CRCW04021K80JNED | Vishay-Dale |
| 1 | R18 | 10.0k | RES, 10.0k ohm, 1%, 0.063W, 0402 | 0402 | CRCW040210K0FKED | Vishay-Dale |
| 1 | R19 | 4.32k | RES, 4.32k ohm, 1%, 0.063W, 0402 | 0402 | CRCW04024K32FKED | Vishay-Dale |
| 1 | R21 | 20.0k | RES, 20.0k ohm, 1%, 0.063W, 0402 | 0402 | CRCW040220K0FKED | Vishay-Dale |
| 1 | R23 | 3.3 | RES, 3.3 ohm, 5%, 0.1W, 0603 | 0603 | CRCW06033R30JNEA | Vishay-Dale |
| 1 | R24 | 3.01k | RES, 3.01k ohm, 1%, 0.063W, 0402 | 0402 | CRCW04023K01FKED | Vishay-Dale |
| 1 | R26 | 1.0 | RES, 1.0 ohm, 5%, 0.125W, 0805 | 0805 | CRCW08051R00JNEA | Vishay-Dale |
| 1 | R100 | 750 | RES, 750 ohm, 1%, 0.063W, 0402 | 0402 | CRCW0402750RFKED | Vishay-Dale |
| 10 | T1, T2, T3, T4, T5, T6, T7, T8, T9, T10 | SMT | Test Point, SMT, Miniature | Testpoint | 5015 | Keystone |
| 3 | TP1, TP2, TP4 | Red | Test Point, TH, Miniature, Red | Testpoint | 5000 | Keystone |
| 3 | TP3, TP5, TP6 | Black | Test Point, TH, Miniature, Black | Testpoint | 5001 | Keystone |
| 1 | U1 | | IC, Economy Primary-Side Controller, 10V Startup | DGK8 | UCC3809-1 | Texas Instruments |
| 1 | U2 | | IC, Optocoupler | SOP-4 | SFH690AT | Vishay |
| 1 | U3 | TL431AxD | IC, Adj Shunt Regulator, 100-mA, 36-V | SO8 | TL431AID | Texas Instruments |

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